### 502257483 03/07/2013

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Kentaro SANO	02/19/2013
Hayato SHIMIZU	02/19/2013

#### **RECEIVING PARTY DATA**

Name:	HITACHI, LTD.
Street Address:	6-6, Marunouchi 1-chome, Chiyoda-ku
City:	Tokyo
State/Country:	JAPAN

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13788869

#### **CORRESPONDENCE DATA**

**Fax Number**: 7036841157

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 703-684-1120

Email: dcashion@mmiplaw.com

Correspondent Name: MATTINGLY & MALUR, PC

Address Line 1: 1800 DIAGONAL ROAD

Address Line 2: SUITE 370

Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: POL-8741

NAME OF SUBMITTER: Shrinath Malur

Total Attachments: 1

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OP \$40.00

PATENT REEL: 029944 FRAME: 0710

# **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi, Ltd., a corporation organized under the laws of Japan, located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi, Ltd., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

# MEASURING DEVICE OF AIR FLOW RATE FOR AIR CONDITIONING SYSTEM

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi, Ltd., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd.,

Signed on the date(s) indicated aside signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) Kentaro SANO Kentaro SANO	2/19/2013
2) Hayato SHIMIZU Huyato Shiniyu	2/14/2013
3)	
4)	
5)	
6)	
7)	
8)	
9)	
0)	

PATENT REEL: 029944 FRAME: 0711

**RECORDED: 03/07/2013**